

#### **Features**

- Top view 0805 package
- Viewing Angle =  $\pm 70^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Green
- RoHS compliance

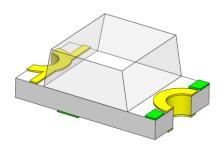
### **Applications**

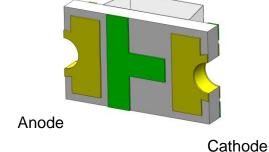
- Optical indicator.
- Switch and Symbol Display.

### **Description**

The GP201208-CTC3 is an AlGalnP Green LED housed in a miniature SMD package. The device has a dominant wavelength of 525 nm LED.

### **Package Outline**





#### **Schematic**

Cathode 
$$\longrightarrow$$
 Anode



### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
I <sub>FP</sub>	Peak Forward Current	60	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

#### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	160	-	400	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =5mA	520	-	535	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±70	1	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =5mA	2.5	-	3.0	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

#### Notes:

- 1. IFP Conditions--Pulse Width $\leq$  100 $\mu$ s and Duty $\leq$  10%.
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition	
02	160	200			
p1	200	250			
p2	250	300	mcd	I <sub>F</sub> =5mA	
q1	300	350			
q2	350	400			

Tolerance of: Luminous Intensity  $\pm 10\%$ 



#### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
A5	520	525		
A6	525	530	nm	I <sub>F</sub> =5mA
A7	530	535		

Tolerance of Dominant Wavelength: ±1nm.

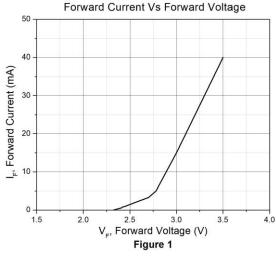
#### 5. Bin Range of Forward Voltage

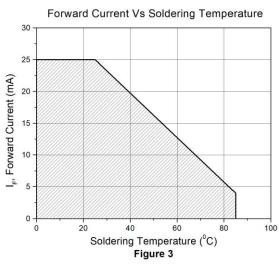
Bin Code	Min	Max	Unit	Condition	
32	2.5	2.6			
33	2.6	2.7			
34	2.7	2.8	V	I <sub>F</sub> =5mA	
35	2.8	2.9			
36	2.9	3.0			

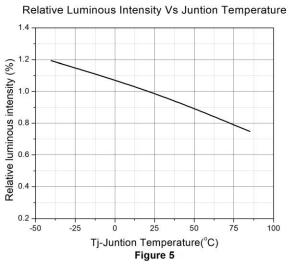
Tolerance of Forward Voltage  $\pm 0.05$ V.

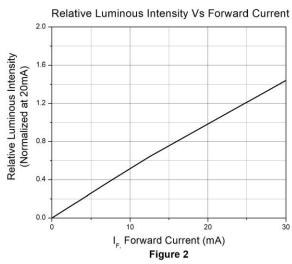


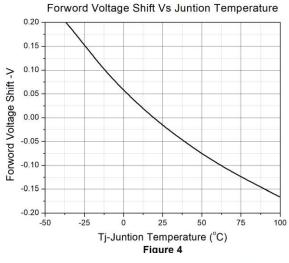
## **Typical Characteristic Curves**

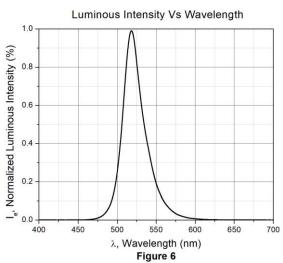














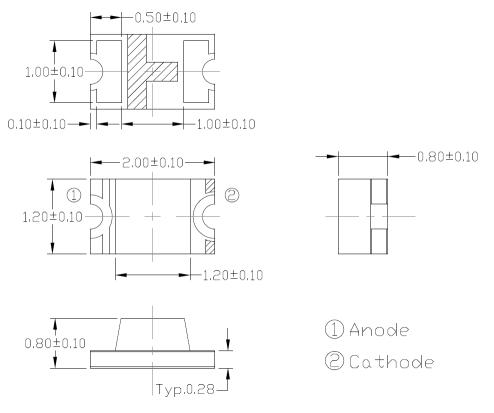
## **Typical Characteristic Curves**

## 

Figure 7

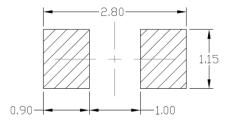


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



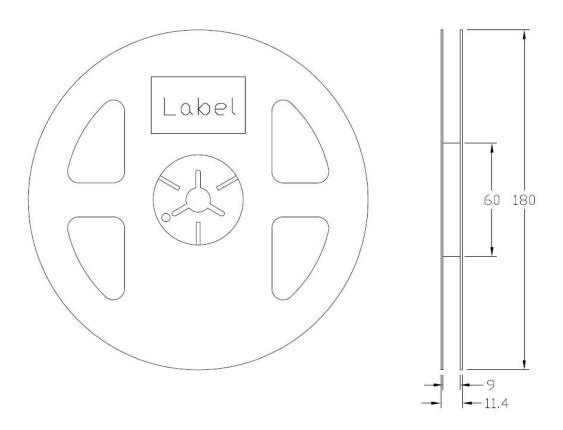
Note: Tolerance unless mentioned is ±0.1mm.

### **Ordering Information**

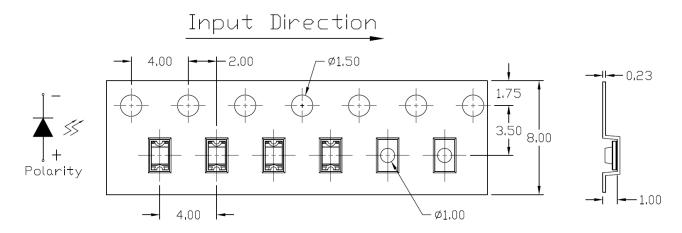
Part Number	Description	Quantity
GP201208-CTC3	Tape & Reel	3000 pcs



### Reel Dimension All dimensions are in mm, unless otherwise stated



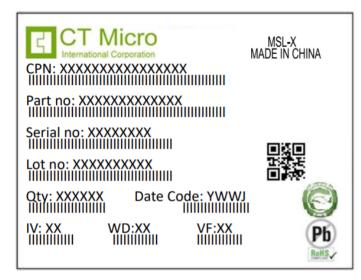
### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



#### **Label Form Specification**



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

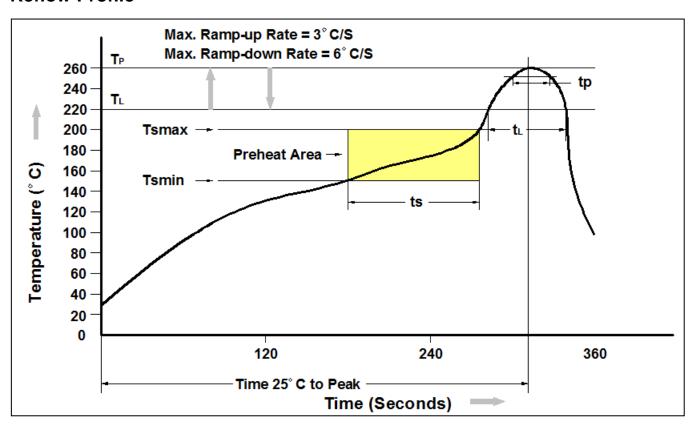
MADE IN CHINA: Production Place

#### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



#### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.